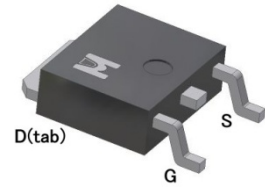
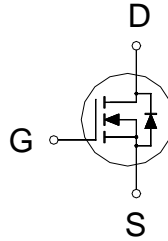


N-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

BV_{DSS}	30V
$R_{DS(on)}$ (MAX.)	4.0m Ω
I_D	90A



UIS, R_g 100% Tested

Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS		UNIT	
		10s	Steady State		
Gate-Source Voltage	V_{GS}	± 20		V	
Continuous Drain Current	I_D	$T_C = 25\text{ }^\circ\text{C}$		A	
		$T_C = 100\text{ }^\circ\text{C}$			
Continuous Drain Current	I_D	$T_A = 25\text{ }^\circ\text{C}$	28		17
		$T_A = 70\text{ }^\circ\text{C}$	22		13
Pulsed Drain Current ¹	I_{DM}	180			
Avalanche Current	I_{AS}	53			
Avalanche Energy	E_{AS}	L = 0.1mH, $I_D=53\text{A}$, $R_G=25\text{ }\Omega$		mJ	
Repetitive Avalanche Energy ²	E_{AR}	L = 0.05mH			
Power Dissipation	P_D	$T_C = 25\text{ }^\circ\text{C}$		W	
		$T_C = 100\text{ }^\circ\text{C}$			
Power Dissipation	P_D	$T_A = 25\text{ }^\circ\text{C}$	6.5	2.5	W
Operating Junction & Storage Temperature Range	T_{j}, T_{stg}	-55 to 175		$^\circ\text{C}$	

100% UIS testing in condition of $V_D=15\text{V}$, $L=0.1\text{mH}$, $V_G=10\text{V}$, $I_L=40\text{A}$, Rated $V_{DS}=30\text{V}$ N-CH

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		1.8	$^\circ\text{C} / \text{W}$
Junction-to-Ambient ³ ($t \leq 10\text{s}$)	$R_{\theta JA}$		23	
Junction-to-Ambient ³	$R_{\theta JA}$		60	

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

³When mounted on a 1 in² pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS (T_C = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.0	1.6	3.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	μA
		V _{DS} = 20V, V _{GS} = 0V, T _J = 125 °C			25	
On-State Drain Current ¹	I _{D(ON)}	V _{DS} = 10V, V _{GS} = 10V	90			A
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 30A		3.2	4.0	mΩ
		V _{GS} = 4.5V, I _D = 24A		4.9	6.6	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 24A		25		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz		3435		pF
Output Capacitance	C _{oss}			485		
Reverse Transfer Capacitance	C _{rss}			457		
Gate Resistance	R _g	V _{GS} = 15mV, V _{DS} = 0V, f = 1MHz		1.2		Ω
Total Gate Charge ^{1,2}	Q _g (V _{GS} =10V)	V _{DS} = 15V, V _{GS} = 10V, I _D = 30A		59		nC
	Q _g (V _{GS} =4.5V)			32		
Gate-Source Charge ^{1,2}	Q _{gs}			6.9		
Gate-Drain Charge ^{1,2}	Q _{gd}			16		
Turn-On Delay Time ^{1,2}	t _{d(on)}		V _{DS} = 15V, I _D = 24A, V _{GS} = 10V, R _{GS} = 2.7Ω		20	
Rise Time ^{1,2}	t _r			20		
Turn-Off Delay Time ^{1,2}	t _{d(off)}			60		
Fall Time ^{1,2}	t _f			25		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_C = 25 °C)						
Continuous Current	I _S				90	A
Pulsed Current ³	I _{SM}				180	
Forward Voltage ¹	V _{SD}	I _F = I _S , V _{GS} = 0V			1.3	V
Reverse Recovery Time	t _{rr}	I _F = I _S , di _F /dt = 100A / μS		35		nS
Peak Reverse Recovery Current	I _{RM(REC)}			200		A
Reverse Recovery Charge	Q _{rr}			30		nC

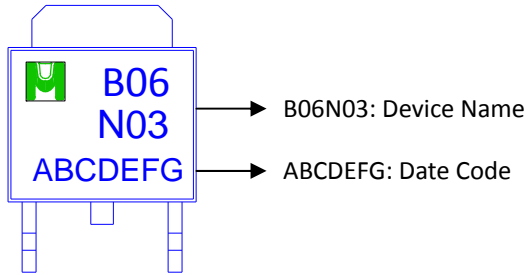
¹Pulse test : Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

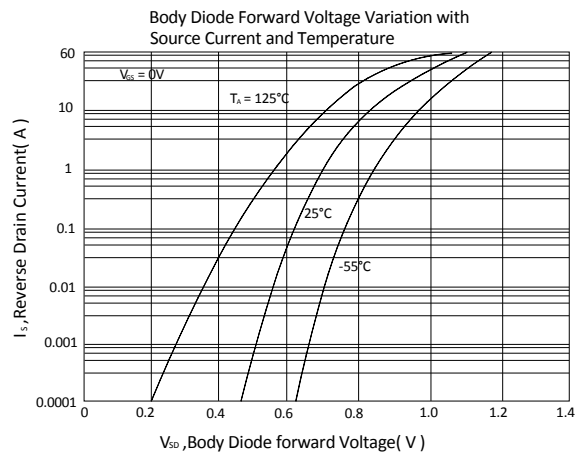
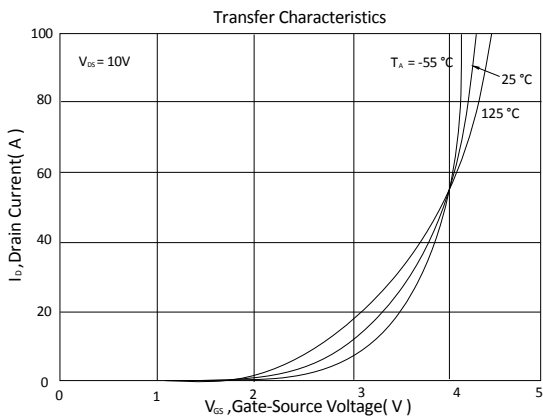
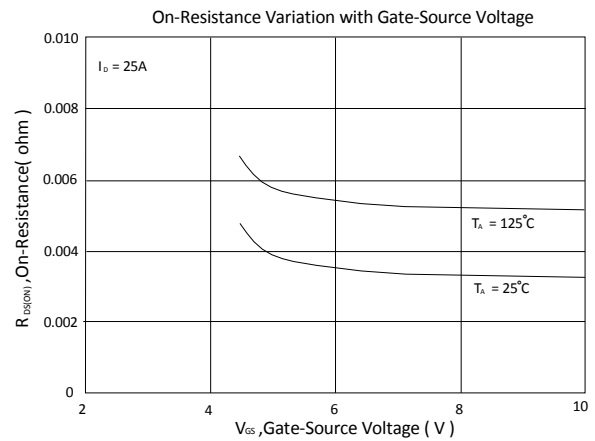
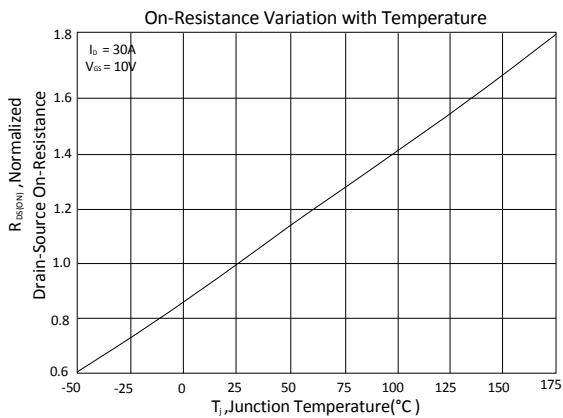
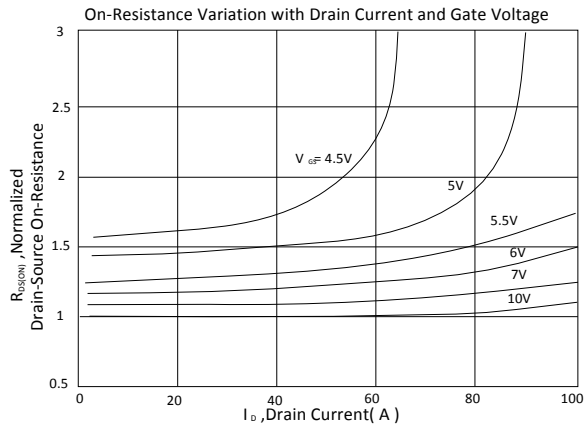
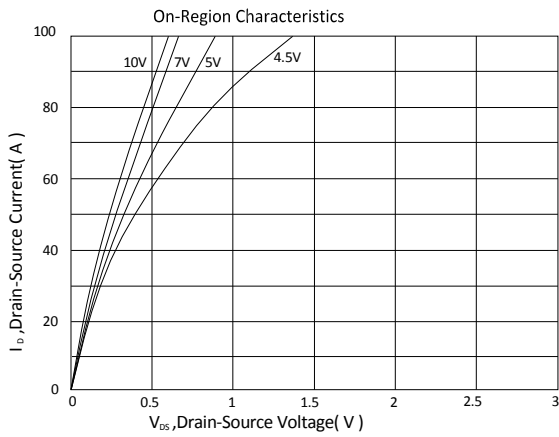
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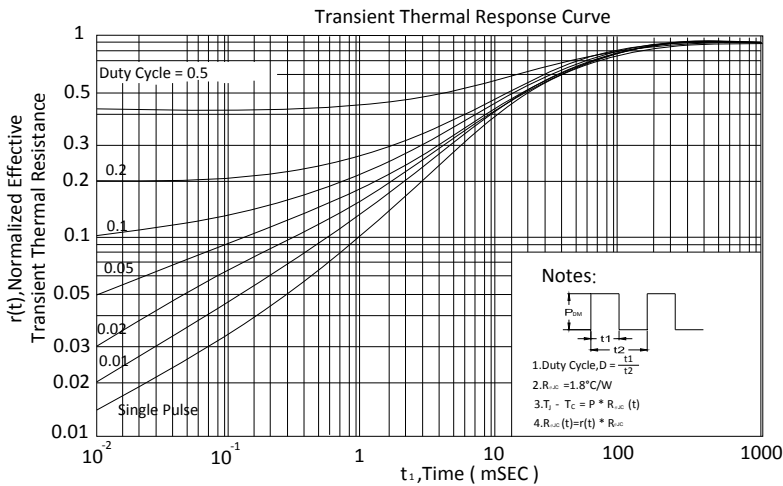
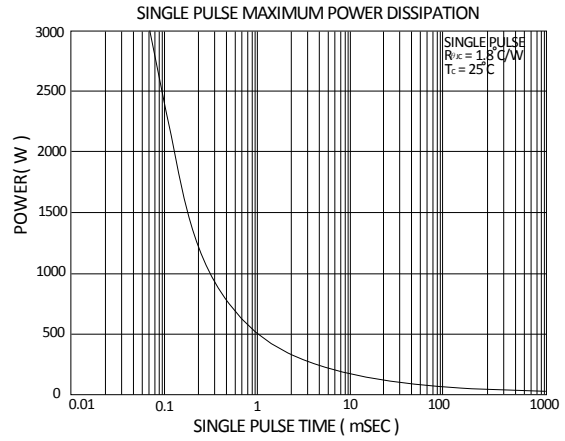
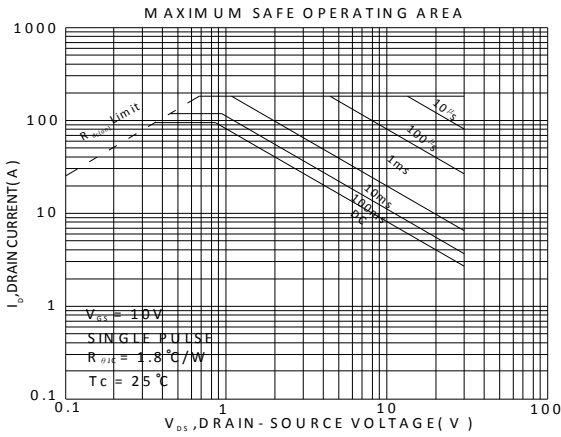
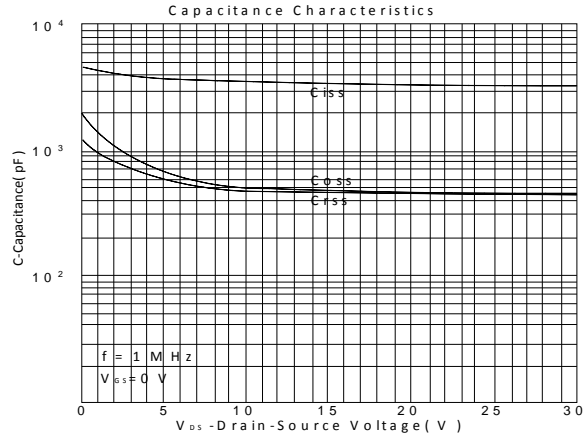
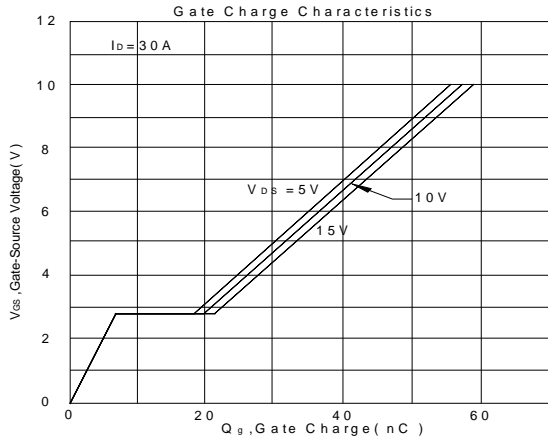
Device Name: EMB06N03AN for DPAK (TO-252)





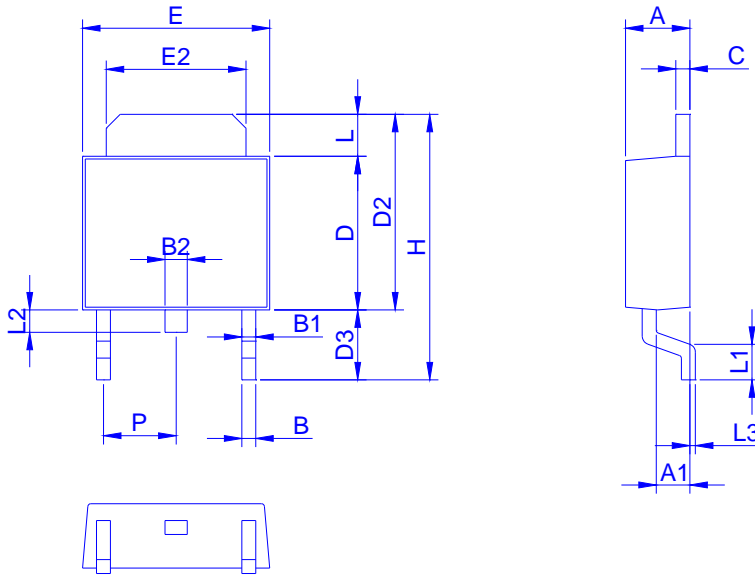
TYPICAL CHARACTERISTICS







Outline Drawing



Dimension	A	A1	B	B1	B2	C	D	D2	D3	E	E2	H	L	L1	L2	L3	P
Min.	2.10	0.95	0.30	0.40	0.60	0.40	5.30	6.70	2.20	6.40	4.80	9.20	0.89	0.90	0.50	0.00	2.10
Max.	2.50	1.30	0.85	0.94	1.00	0.60	6.20	7.30	3.00	6.70	5.45	10.15	1.70	1.65	1.10	0.30	2.50

Footprint

